

Product Information Sheet

EPO-TEK® 301-104

Date: June 2017 Rev: I
No. of Components: Single
Mix Ratio by Weight: N/A
Specific Gravity: 1.08

Pot Life: 1 - 2 Hours

Shelf Life- Bulk: Four months at -40°C

Minimum Alternative Cure(s):

may not achieve performance properties below

65°C / 2 Hours

23°C / 24 Hours

Recommended Cure:

NOTES:

- Container(s) should be kept closed when not in use.
- Filled systems should be stirred thoroughly before mixing and prior to use.
- Performance properties (rheology, conductivity, others) of the Products may vary from those stated on the data sheet when bi-pak/syringe packaging or post-processing of any kind is performed. Epoxy's warranties shall not apply to any products that have been reprocessed or repackaged from Epoxy's delivered status/container into any other containers of any kind, including but not limited to syringes, bi-paks, cartridges, pouches, tubes, capsules, films or other packages.
- Syringe packaging will impact initial viscosity and effective pot life, potentially beyond stated parameters.
- TOTAL MASS SHOULD NOT EXCEED 25 GRAMS

<u>Product Description:</u> EPO-TEK® 301-104 is a single component, room temperature curing epoxy featruing very low viscosity and excellent optical-mechanical properties.

<u>Typical Properties:</u> Cure condition: varies as required *denotes test on lot acceptance basis Data below is not guaranteed.

To be used as a guide only, not as a specification. Different batches, conditions & applications yield differing results.

PHYSICAL PROPERTIES:	,	•	,
* Color (before cure):	Clear/colorless		
* Consistency:	Pourable liquid		
* Viscosity (23°C) @ 100 rpm:		100 - 200	cPs
Thixotropic Index:		N/A	
* Glass Transition Temp:		≥ 65	°C (Dynamic Cure:20-200°C/ISO 25 Min; Ramp -10-200°C @ 20°C/Min)
Coefficient of Thermal Expansion (CTE):			·
	Below Tg:	39	x 10 ⁻⁶ in/in°C
	Above Tg:	98	x 10 ⁻⁶ in/in°C
Shore D Hardness:		85	
Lap Shear @ 23°C:		> 2,000	psi
Die Shear @ 23°C:		≥ 15 Kg	5,334 psi
Degradation Temp:		341	°C
Weight Loss:	@ 200°C	0.40	%
	@ 250°C	0.60	%
	@ 300°C	1.72	%
Suggested Operating Temperature:		< 275	°C (Intermittent)
Storage Modulus:		337,463	psi
* Particle Size:		N/A	

99% @ 382-980 nm
7% @ 980-1640 nm
% @ 1640-2040 nm
1.5212 @ 589 nm
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